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Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

Product Status	Obsolete
Programmable Type	In-System Reprogrammable™ (ISR™) CMOS
Delay Time tpd(1) Max	6.5 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	-
Number of Macrocells	64
Number of Gates	-
Number of I/O	37
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy37064vp44-143axc

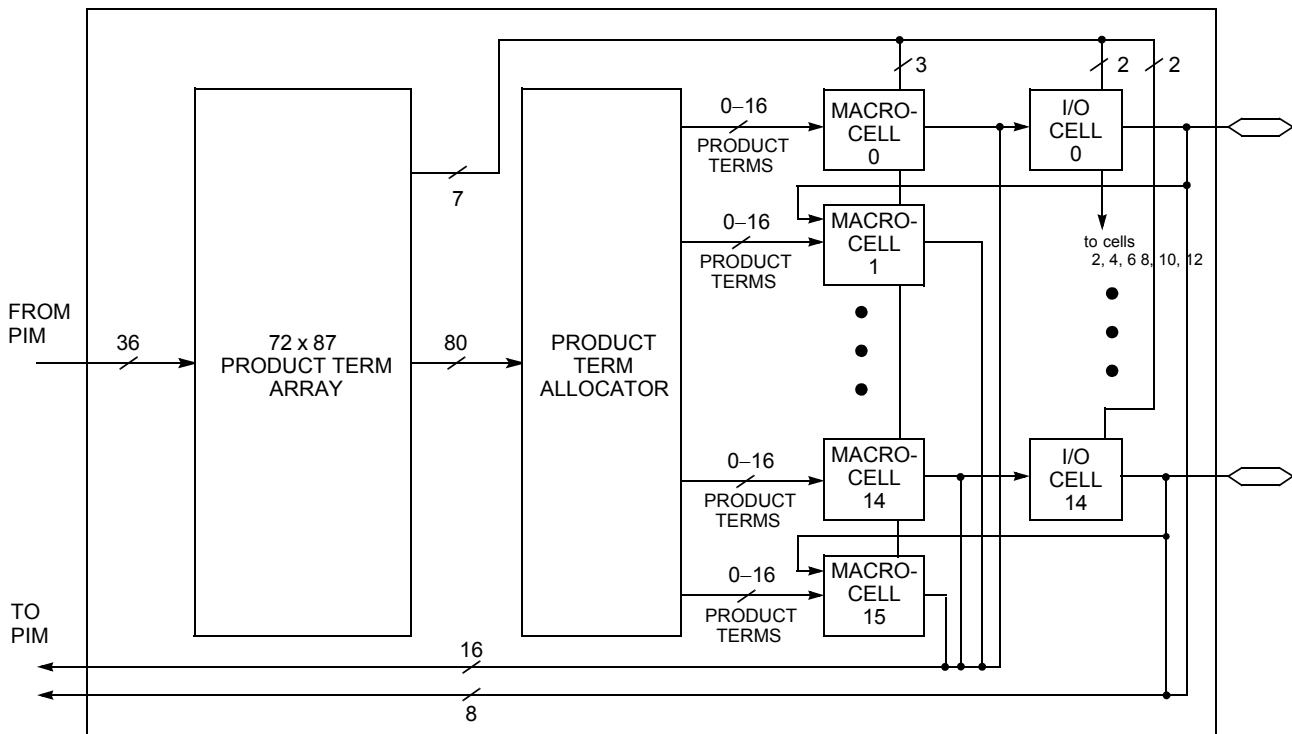


Figure 1. Logic Block with 50% Buried Macrocells

Low-Power Option

Each logic block can operate in high-speed mode for critical path performance, or in low-power mode for power conservation. The logic block mode is set by the user on a logic block basis.

Product Term Allocator

Through the product term allocator, software automatically distributes product terms among the 16 macrocells in the logic block as needed. A total of 80 product terms are available from the local product term array. The product term allocator provides two important capabilities without affecting performance: product term steering and product term sharing.

Product Term Steering

Product term steering is the process of assigning product terms to macrocells as needed. For example, if one macrocell requires ten product terms while another needs just three, the product term allocator will “steer” ten product terms to one macrocell and three to the other. On Ultra37000 devices, product terms are steered on an individual basis. Any number between 0 and 16 product terms can be steered to any macrocell. Note that 0 product terms is useful in cases where a particular macrocell is unused or used as an input register.

Product Term Sharing

Product term sharing is the process of using the same product term among multiple macrocells. For example, if more than one output has one or more product terms in its equation that are common to other outputs, those product terms are only programmed once. The Ultra37000 product term allocator allows sharing across groups of four output macrocells in a

variable fashion. The software automatically takes advantage of this capability—the user does not have to intervene.

Note that neither product term sharing nor product term steering have any effect on the speed of the product. All worst-case steering and sharing configurations have been incorporated in the timing specifications for the Ultra37000 devices.

Ultra37000 Macrocell

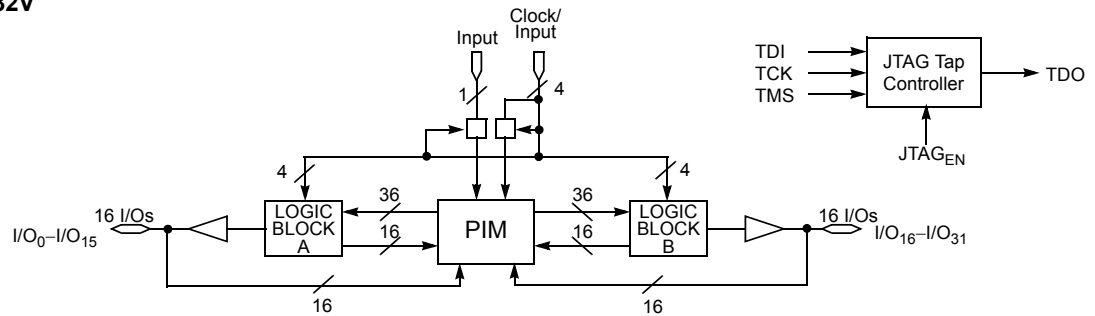
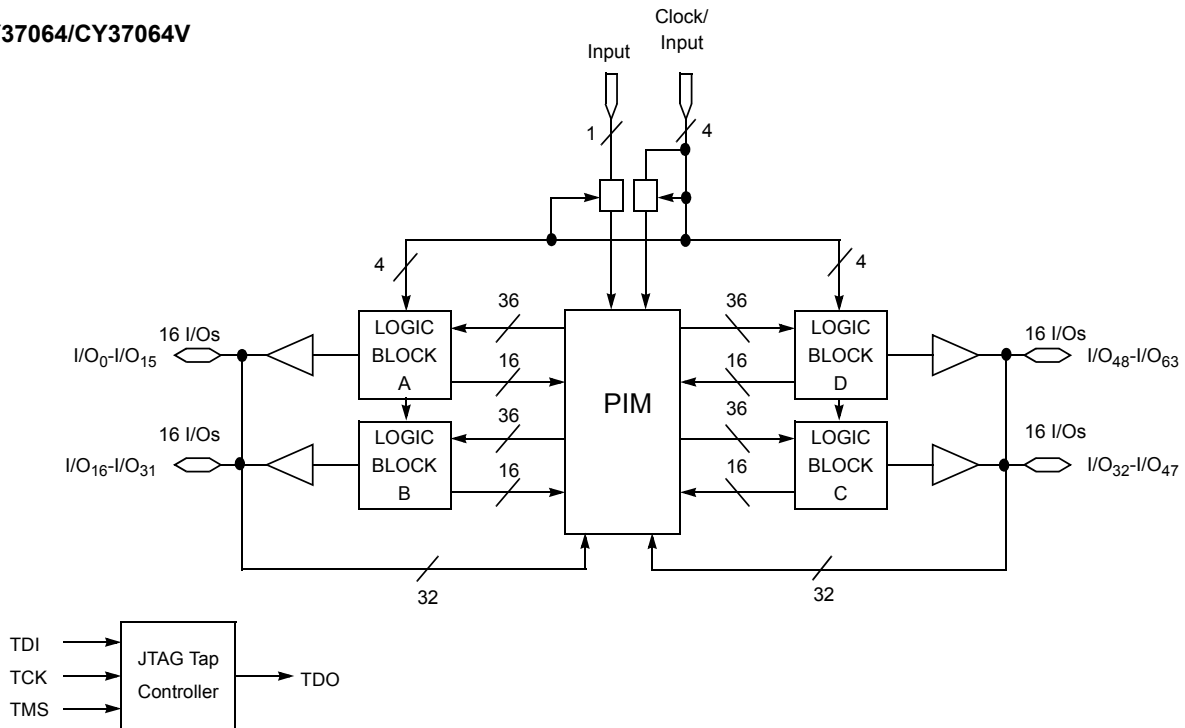
Within each logic block there are 16 macrocells. Macrocells can either be I/O Macrocells, which include an I/O Cell which is associated with an I/O pin, or buried Macrocells, which do not connect to an I/O. The combination of I/O Macrocells and buried Macrocells varies from device to device.

Buried Macrocell

Figure 2 displays the architecture of buried macrocells. The buried macrocell features a register that can be configured as combinatorial, a D flip-flop, a T flip-flop, or a level-triggered latch.

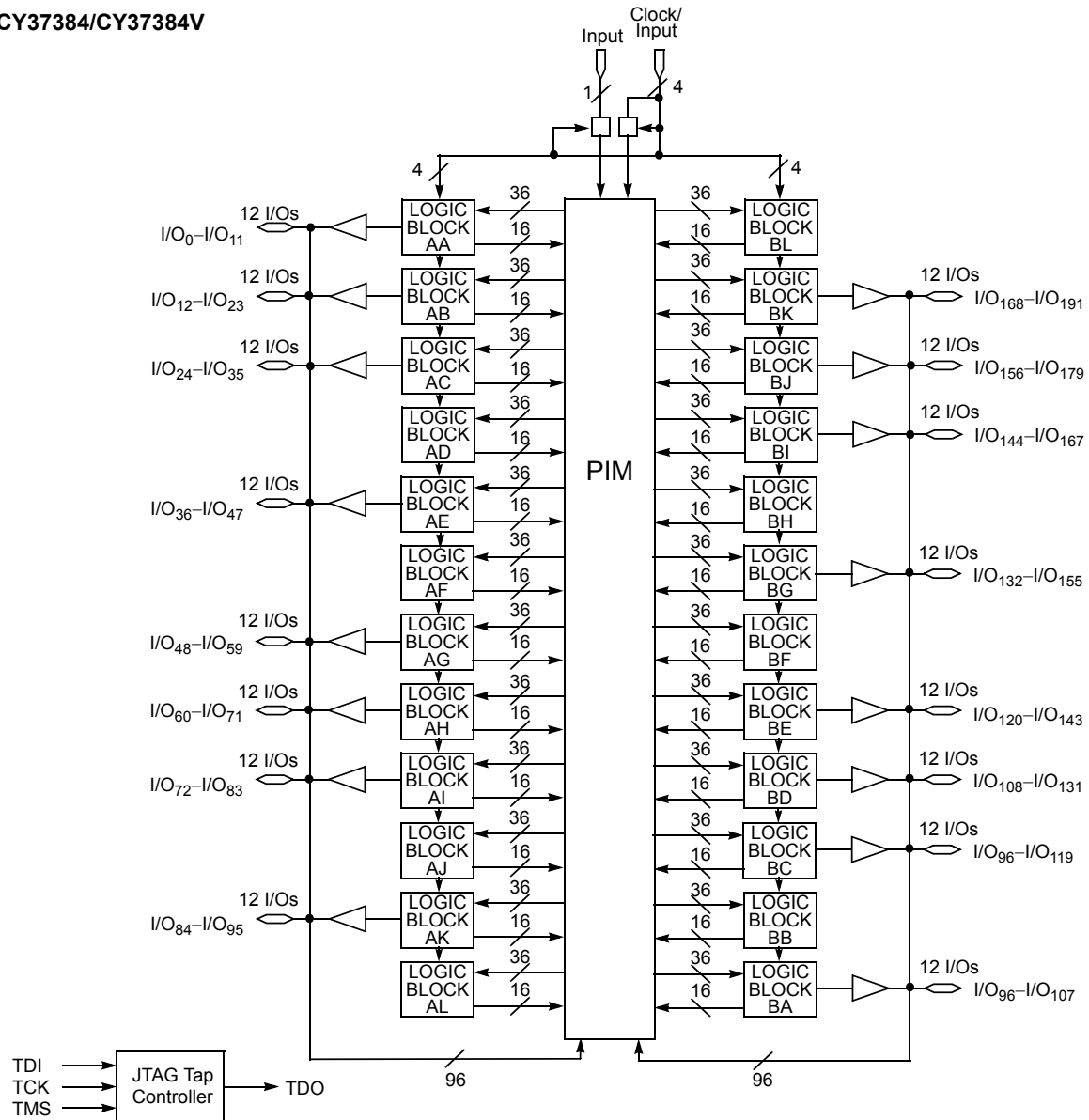
The register can be asynchronously set or asynchronously reset at the logic block level with the separate set and reset product terms. Each of these product terms features programmable polarity. This allows the registers to be set or reset based on an AND expression or an OR expression.

Clocking of the register is very flexible. Four global synchronous clocks and a product term clock are available to clock the register. Furthermore, each clock features programmable polarity so that registers can be triggered on falling as well as rising edges (see the Clocking section). Clock polarity is chosen at the logic block level.

Logic Block Diagrams
CY37032/CY37032V

CY37064/CY37064V


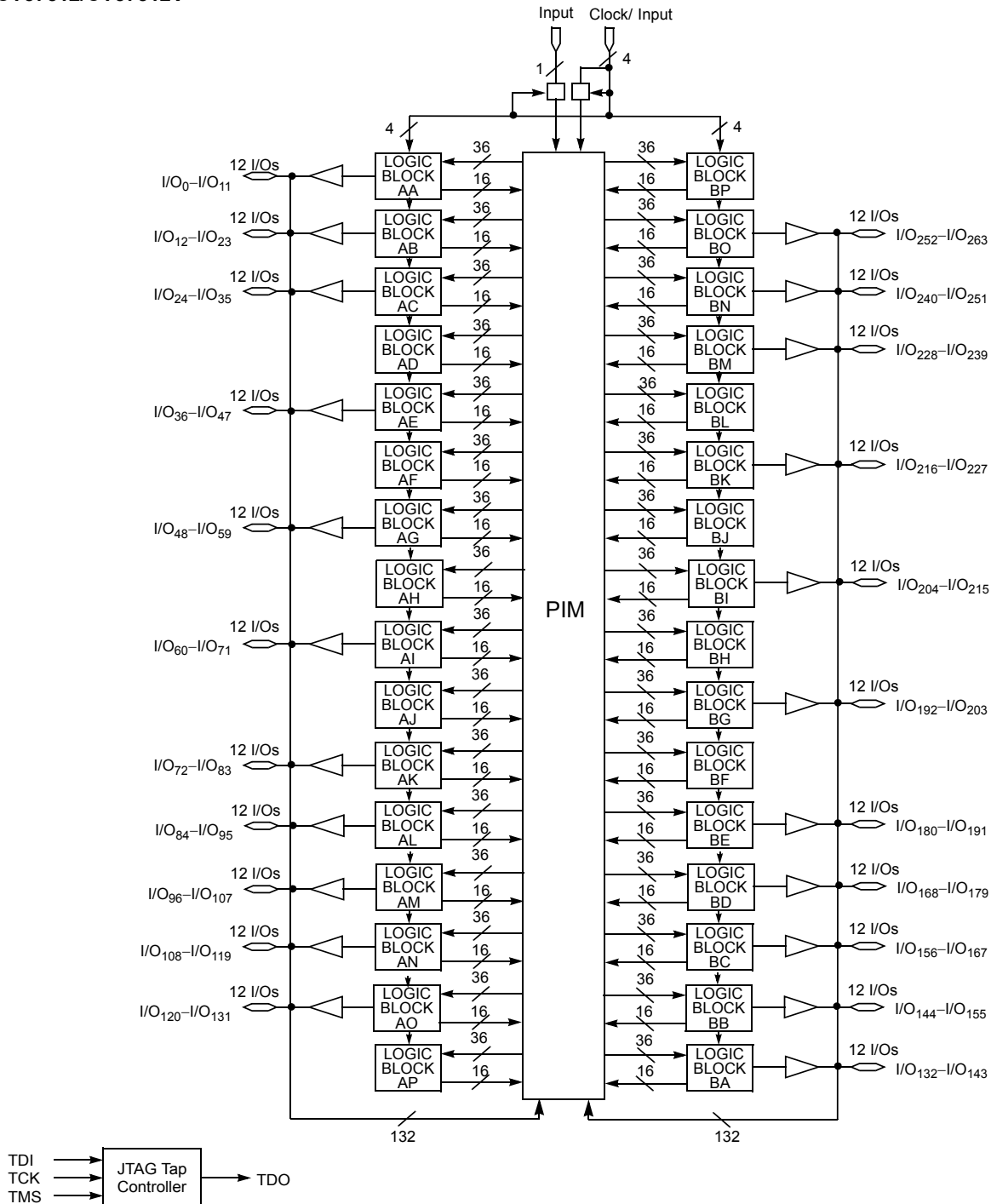
Logic Block Diagrams (continued)

CY37384/CY37384V



Logic Block Diagrams (continued)

CY37512/CY37512V



5.0V Device Characteristics

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature -65°C to +150°C

Ambient Temperature with

Power Applied -55°C to +125°C

Supply Voltage to Ground Potential -0.5V to +7.0V

DC Voltage Applied to Outputs

in High-Z State -0.5V to +7.0V

DC Input Voltage -0.5V to +7.0V

DC Program Voltage 4.5 to 5.5V

Current into Outputs 16 mA

Static Discharge Voltage > 2001V
(per MIL-STD-883, Method 3015)

Latch-up Current > 200 mA

Operating Range^[2]

Range	Ambient Temperature ^[2]	Junction Temperature	Output Condition	V _{CC}	V _{CCO}
Commercial	0°C to +70°C	0°C to +90°C	5V	5V ± 0.25V	5V ± 0.25V
			3.3V	5V ± 0.25V	3.3V ± 0.3V
Industrial	-40°C to +85°C	-40°C to +105°C	5V	5V ± 0.5V	5V ± 0.5V
			3.3V	5V ± 0.5V	3.3V ± 0.3V
Military ^[3]	-55°C to +125°C	-55°C to +130°C	5V	5V ± 0.5V	5V ± 0.5V
			3.3V	5V ± 0.5V	3.3V ± 0.3V

5.0V Device Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	Min.	Typ.	Max.	Unit
V _{OH}	Output HIGH Voltage	V _{CC} = Min. I _{OH} = -3.2 mA (Com'I/Ind) ^[4] I _{OH} = -2.0 mA (Mil) ^[4]	2.4 2.4			V
V _{OHZ}	Output HIGH Voltage with Output Disabled ^[5]	V _{CC} = Max. I _{OH} = 0 μA (Com'I) ^[6] I _{OH} = 0 μA (Ind/Mil) ^[6] I _{OH} = -100 μA (Com'I) ^[6] I _{OH} = -150 μA (Ind/Mil) ^[6]			4.2 4.5 3.6 3.6	V
V _{OL}	Output LOW Voltage	V _{CC} = Min. I _{OL} = 16 mA (Com'I/Ind) ^[4] I _{OL} = 12 mA (Mil) ^[4]			0.5 0.5	V
V _{IH}	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs ^[7]	2.0		V _{CCmax}	V
V _{IL}	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs ^[7]	-0.5		0.8	V
I _{IX}	Input Load Current	V _I = GND OR V _{CC} , Bus-Hold Disabled	-10		10	μA
I _{OZ}	Output Leakage Current	V _O = GND or V _{CC} , Output Disabled, Bus-Hold Disabled	-50		50	μA
I _{OS}	Output Short Circuit Current ^[5, 8]	V _{CC} = Max., V _{OUT} = 0.5V	-30		-160	mA
I _{BHL}	Input Bus-Hold LOW Sustaining Current	V _{CC} = Min., V _{IL} = 0.8V	+75			μA
I _{BHH}	Input Bus-Hold HIGH Sustaining Current	V _{CC} = Min., V _{IH} = 2.0V	-75			μA
I _{BHLO}	Input Bus-Hold LOW Overdrive Current	V _{CC} = Max.			+500	μA
I _{BHHO}	Input Bus-Hold HIGH Overdrive Current	V _{CC} = Max.			-500	μA

Notes:

- Normal Programming Conditions apply across Ambient Temperature Range for specified programming methods. For more information on programming the Ultra37000 Family devices, please refer to the Application Note titled "An Introduction to In System Reprogramming with the Ultra37000."
- T_A is the "Instant On" case temperature.
- I_{OH} = -2 mA, I_{OL} = 2 mA for TDO.
- Tested initially and after any design or process changes that may affect these parameters.
- When the I/O is output disabled, the bus-hold circuit can weakly pull the I/O to above 3.6V if no leakage current is allowed. Note that all I/Os are output disabled during ISR programming. Refer to the application note "Understanding Bus-Hold" for additional information.
- These are absolute values with respect to device ground. All overshoots due to system or tester noise are included.
- Not more than one output should be tested at a time. Duration of the short circuit should not exceed 1 second. V_{OUT} = 0.5V has been chosen to avoid test problems caused by tester ground degradation.

Inductance^[5]

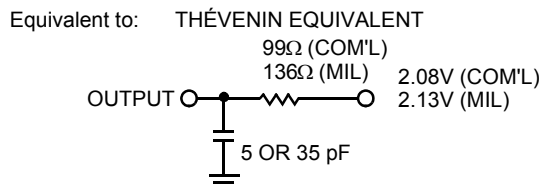
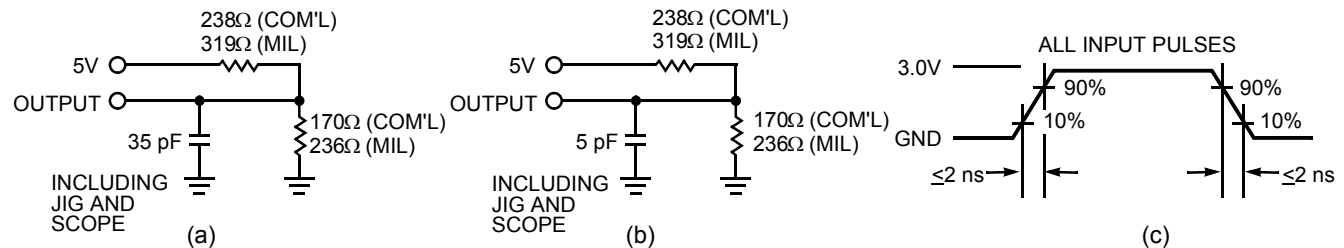
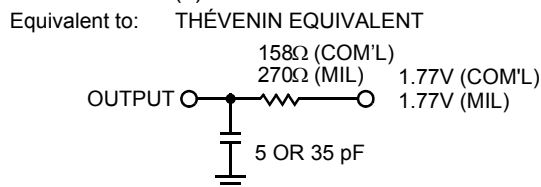
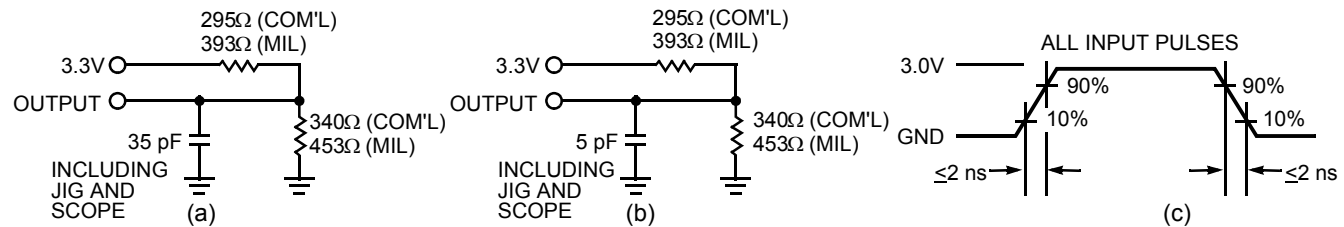
Parameter	Description	Test Conditions	44-Lead TQFP	44-Lead PLCC	44-Lead CLCC	84-Lead PLCC	84-Lead CLCC	100-Lead TQFP	160-Lead TQFP	208-Lead PQFP	Unit
L	Maximum Pin Inductance	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$	2	5	2	8	5	8	9	11	nH

Capacitance^[5]

Parameter	Description	Test Conditions	Max.	Unit
$C_{I/O}$	Input/Output Capacitance	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	8	pF
C_{CLK}	Clock Signal Capacitance	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	12	pF
C_{DP}	Dual Functional Pins ^[9]	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	16	pF

Endurance Characteristics^[5]

Parameter	Description	Test Conditions	Min.	Typ.	Unit
N	Minimum Reprogramming Cycles	Normal Programming Conditions ^[2]	1,000	10,000	Cycles

AC Characteristics
5.0V AC Test Loads and Waveforms

3.3V AC Test Loads and Waveforms


Switching Characteristics Over the Operating Range ^[12]

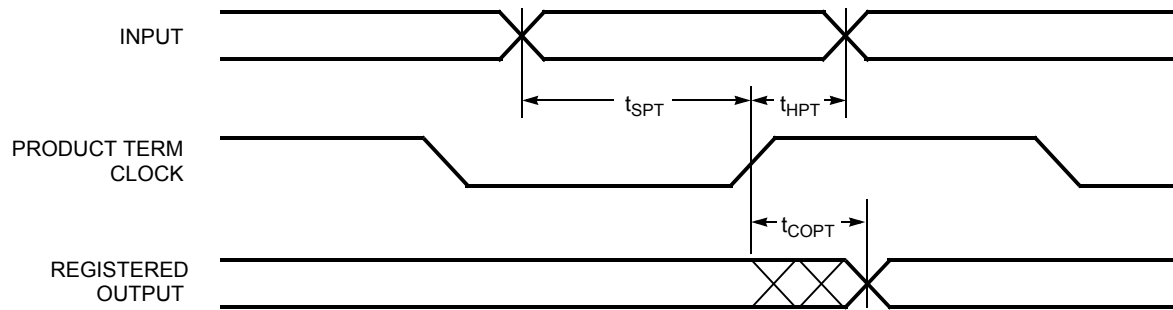
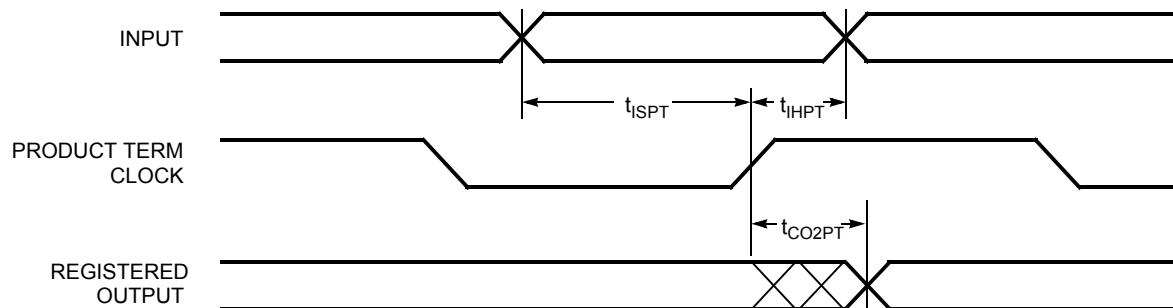
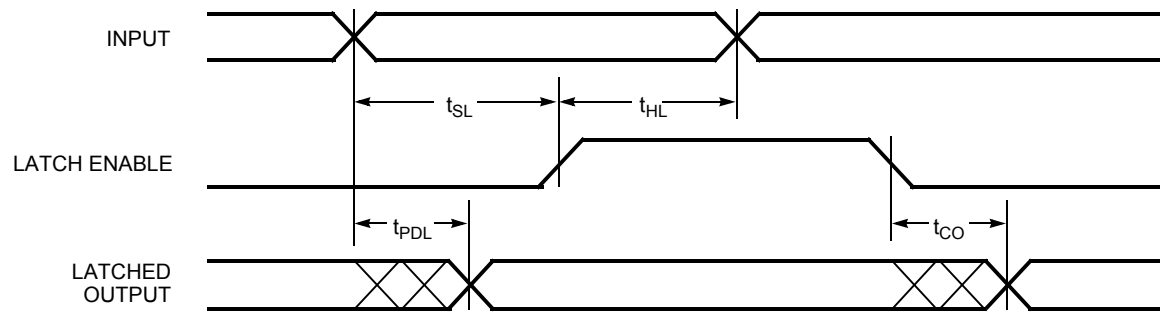
Parameter	200 MHz		167 MHz		154 MHz		143 MHz		125 MHz		100 MHz		83 MHz		66 MHz		Unit
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
Combinatorial Mode Parameters																	
t _{PD} ^[13, 14, 15]		6		6.5		7.5		8.5		10		12		15		20	ns
t _{PDL} ^[13, 14, 15]		11		12.5		14.5		16		16.5		17		19		22	ns
t _{PDLL} ^[13, 14, 15]		12		13.5		15.5		17		17.5		18		20		24	ns
t _{EA} ^[13, 14, 15]		8		8.5		11		13		14		16		19		24	ns
t _{ER} ^[11, 13]		8		8.5		11		13		14		16		19		24	ns
Input Register Parameters																	
t _{WL}	2.5		2.5		2.5		2.5		3		3		4		5		ns
t _{WH}	2.5		2.5		2.5		2.5		3		3		4		5		ns
t _{IS}	2		2		2		2		2		2.5		3		4		ns
t _{IH}	2		2		2		2		2		2.5		3		4		ns
t _{ICO} ^[13, 14, 15]		11		11		11		12.5		12.5		16		19		24	ns
t _{ICOL} ^[13, 14, 15]		12		12		12		14		16		18		21		26	ns
Synchronous Clocking Parameters																	
t _{CO} ^[14, 15]		4		4		4.5		6		6.5 ^[16]		6.5 ^[17]		8 ^[18]		10	ns
t _S ^[13]	4		4		5		5		5.5 ^[16]		6 ^[17]		8 ^[18]		10		ns
t _H	0		0		0		0		0		0		0		0		ns
t _{CO2} ^[13, 14, 15]		9.5		10		11		12		14		16		19		24	ns
t _{SCS} ^[13]	5		6		6.5		7		8 ^[16]		10		12		15		ns
t _{SL} ^[13]	7.5		7.5		8.5		9		10		12		15		15		ns
t _{HL}	0		0		0		0		0		0		0		0		ns
Product Term Clocking Parameters																	
t _{COPT} ^[13, 14, 15]		7		10		10		13		13		13		15		20	ns
t _{SPT}	2.5		2.5		2.5		3		5		5.5		6		7		ns
t _{HPT}	2.5		2.5		2.5		3		5		5.5		6		7		ns
t _{ISPT} ^[13]	0		0		0		0		0		0		0		0		ns
t _{IHPT}	6		6.5		6.5		7.5		9		11		14		19		ns
t _{CO2PT} ^[13, 14, 15]		12		14		15		19		19		21		24		30	ns
Pipelined Mode Parameters																	
t _{ICS} ^[13]	5		6		6		7		8 ^[16]		10		12		15		ns
Operating Frequency Parameters																	
f _{MAX1}	200		167		154		143		125 ^[16]		100		83		66		MHz
f _{MAX2}	200		200		200		167		154		153 ^[17]		125 ^[18]		100		MHz
f _{MAX3}	125		125		105		91		83		80 ^[17]		62.5		50		MHz
f _{MAX4}	167		167		154		125		118		100		83		66		MHz
Reset/Preset Parameters																	
t _{RW}	8		8		8		8		10		12		15		20		ns
t _{RR} ^[13]	10		10		10		10		12		14		17		22		ns

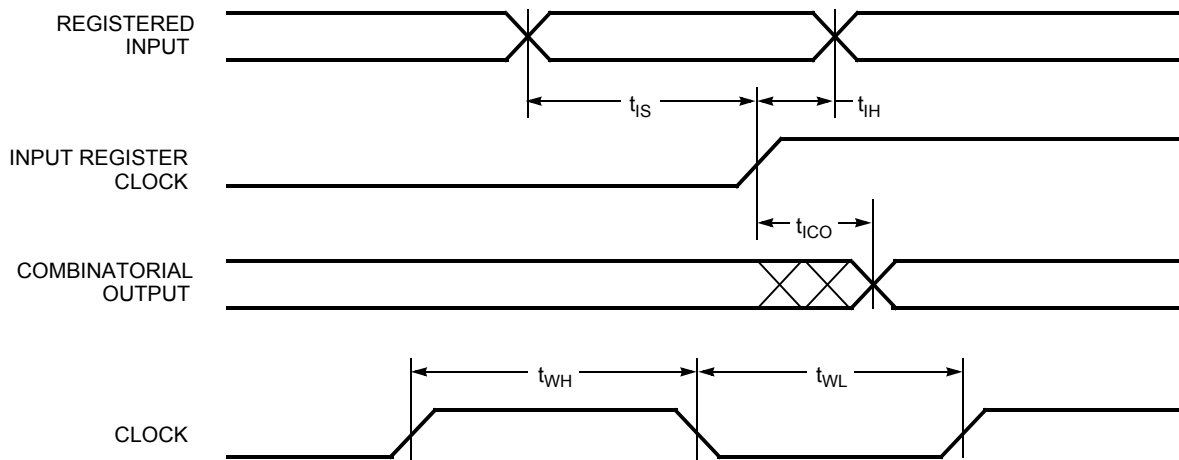
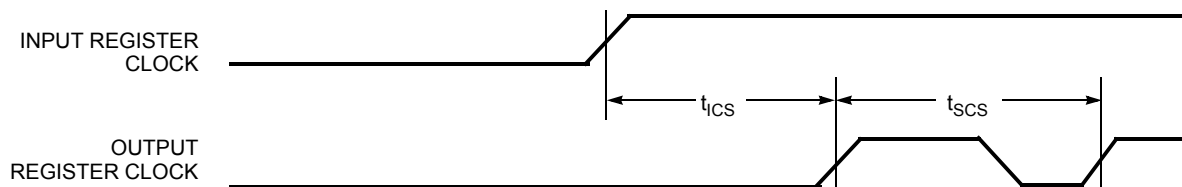
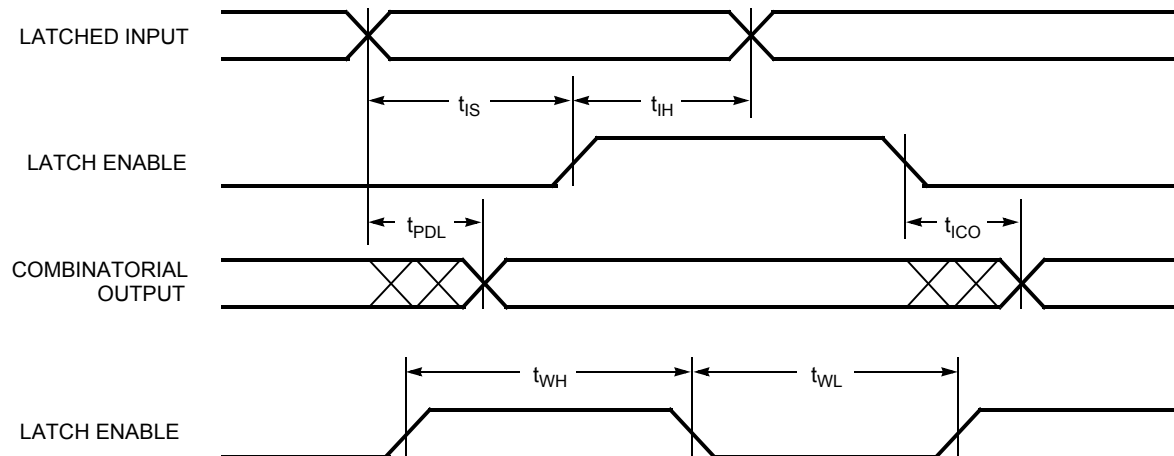
Notes:

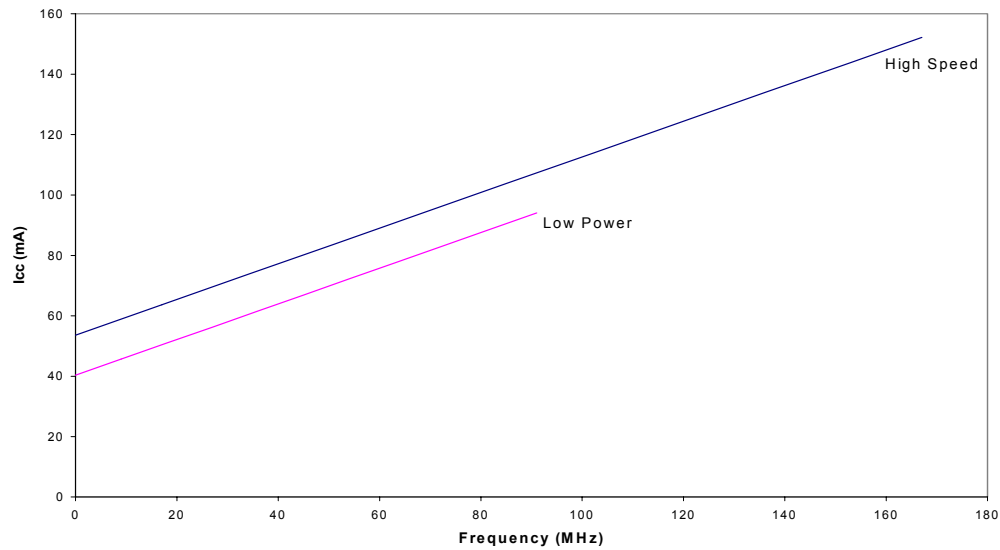
16. The following values correspond to the CY37512 and CY37384 devices: $t_{CO} = 5$ ns, $t_S = 6.5$ ns, $t_{SCS} = 8.5$ ns, $t_{ICS} = 8.5$ ns, $f_{MAX1} = 118$ MHz.

17. The following values correspond to the CY37192V and CY37256V devices: $t_{CO} = 6$ ns, $t_S = 7$ ns, $f_{MAX2} = 143$ MHz, $f_{MAX3} = 77$ MHz, and $f_{MAX4} = 100$ MHz; and for the CY37512 devices: $t_S = 7$ ns.

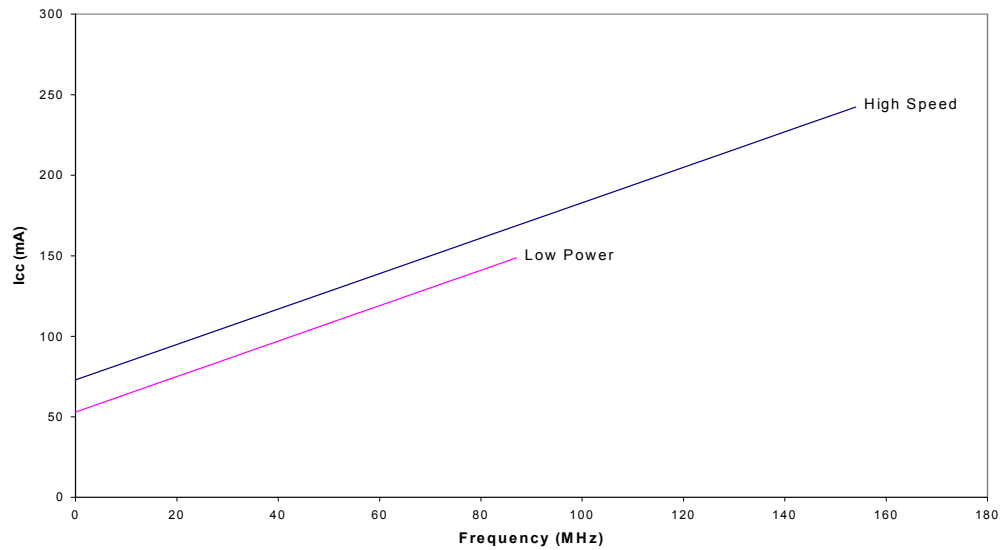
18. The following values correspond to the CY37512V and CY37384V devices: $t_{CO} = 6.5$ ns, $t_S = 9.5$ ns, and $f_{MAX2} = 105$ MHz.

Switching Waveforms (continued)
Registered Output with Product Term Clocking Input Going Through the Array

Registered Output with Product Term Clocking Input Coming From Adjacent Buried Register

Latched Output


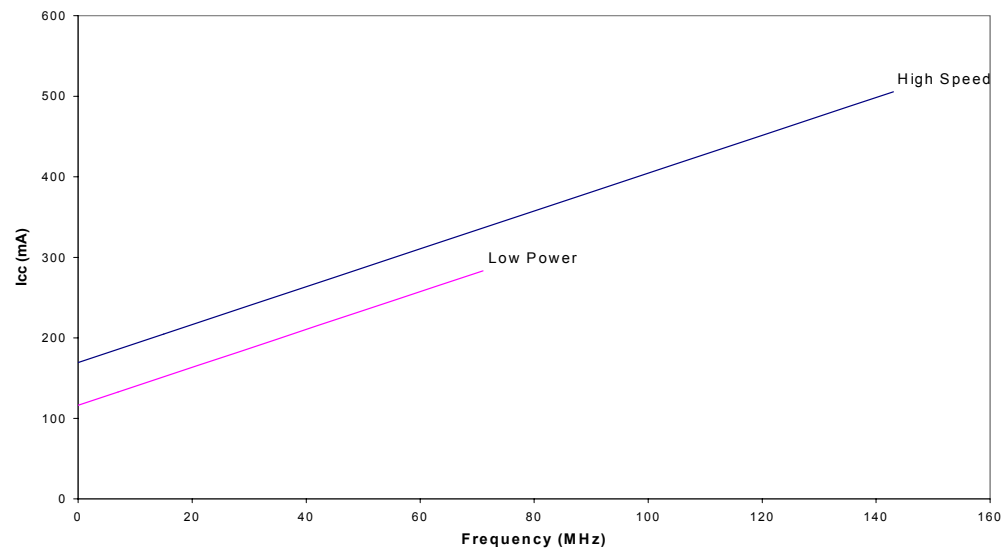
Switching Waveforms (continued)
Registered Input

Clock to Clock

Latched Input


Typical 5.0V Power Consumption (continued)
CY37128


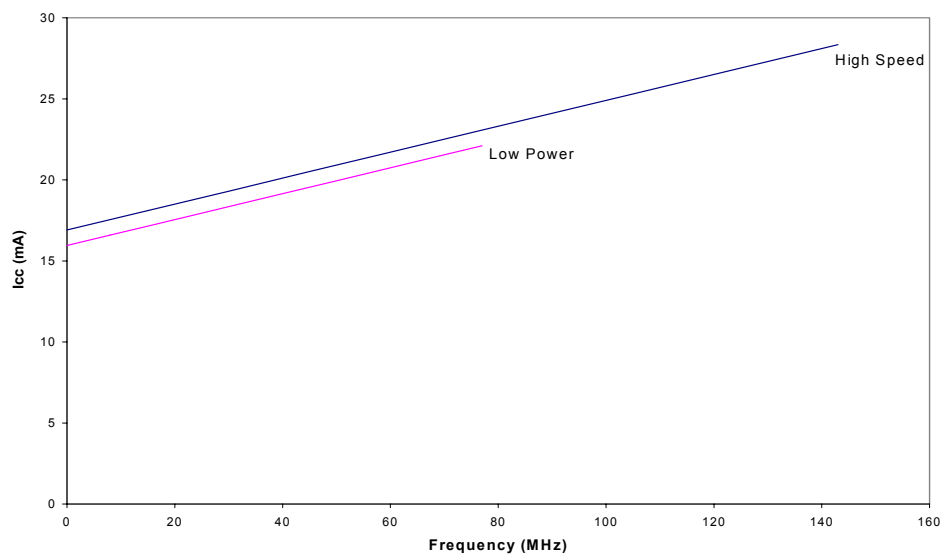
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
 $V_{CC} = 5.0V$, $T_A = \text{Room Temperature}$

CY37192


The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
 $V_{CC} = 5.0V$, $T_A = \text{Room Temperature}$

Typical 5.0V Power Consumption (continued)
CY37512


The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
 $V_{CC} = 5.0V$, $T_A = \text{Room Temperature}$

Typical 3.3V Power Consumption
CY37032V


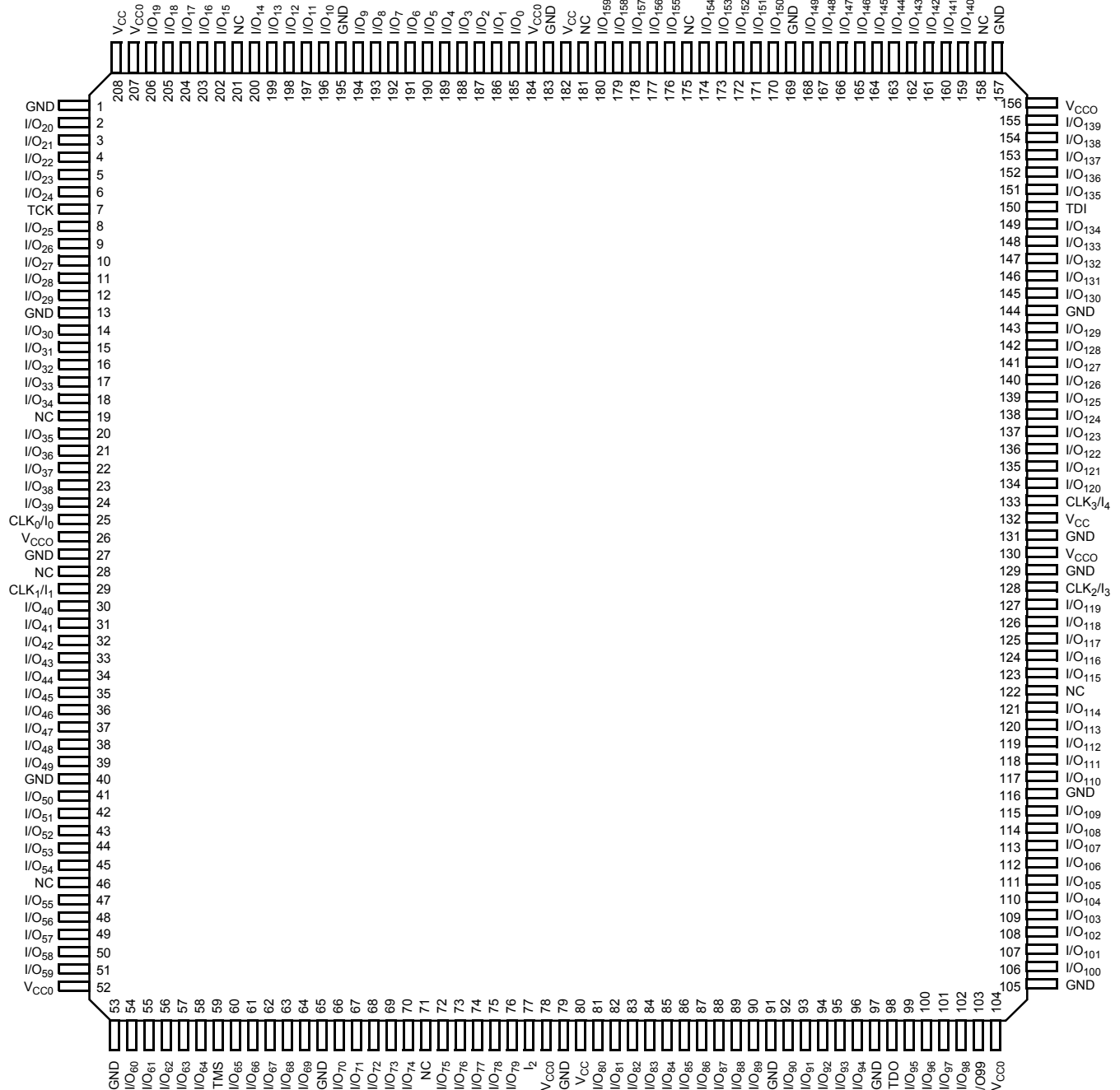
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
 $V_{CC} = 3.3V$, $T_A = \text{Room Temperature}$

Pin Configurations^[20] (continued)
100-ball Fine-Pitch BGA (BB100) for CY37064V
Top View

	1	2	3	4	5	6	7	8	9	10
A	NC	NC	I/O ₇	I/O ₅	I/O ₂	I/O ₆₂	I/O ₆₀	I/O ₅₈	I/O ₅₇	I/O ₅₆
B	I/O ₉	I/O ₈	I/O ₆	I/O ₄	I/O ₁	I/O ₆₃	V _{CC}	I/O ₅₉	I/O ₅₅	NC
C	I/O ₁₀	TCK	V _{CC}	I/O ₃	NC	NC	I/O ₆₁	V _{CC}	TDI	I/O ₅₄
D	I/O ₁₁	NC	I/O ₁₂	I/O ₁₃	I/O ₀	NC	I/O ₅₁	I/O ₅₂	CLK ₃ / I ₄	I/O ₅₃
E	I/O ₁₄	CLK ₀ / I ₀	I/O ₁₅	NC	GND	GND	I/O ₄₈	I/O ₄₉	CLK ₂ / I ₃	I/O ₅₀
F	I/O ₁₇	NC	NC	I/O ₁₆	GND	GND	NC	NC	I ₂	I/O ₄₇
G	I/O ₂₂	CLK ₁ / I ₁	I/O ₂₁	I/O ₁₉	I/O ₁₈	I/O ₄₆	I/O ₄₅	I/O ₄₄	NC	I/O ₄₃
H	I/O ₂₃	TMS	V _{CC}	I/O ₂₀	NC	I/O ₃₂	I/O ₄₂	V _{CC}	TDO	I/O ₄₁
J	NC	I/O ₂₆	I/O ₂₈	NC	I/O ₃₁	I/O ₃₃	I/O ₃₅	I/O ₃₇	I/O ₃₉	I/O ₄₀
K	I/O ₂₄	I/O ₂₅	I/O ₂₇	I/O ₂₉	I/O ₃₀	I/O ₃₄	I/O ₃₆	I/O ₃₈	NC	NC

100-ball Fine-Pitch BGA (BB100) for CY37128V
Top View

	1	2	3	4	5	6	7	8	9	10
A	NC	I/O ₉	I/O ₈	I/O ₆	I/O ₃	I/O ₇₆	I/O ₇₄	I/O ₇₂	I/O ₇₁	I/O ₇₀
B	I/O ₁₁	I/O ₁₀	I/O ₇	I/O ₅	I/O ₂	I/O ₇₇	V _{CC}	I/O ₇₃	I/O ₆₈	I/O ₆₉
C	I/O ₁₂	I/O ₁₃ TCK	V _{CC}	I/O ₄	I/O ₁	I/O ₇₈	I/O ₇₅	V _{CC}	I/O ₆₇ TDI	I/O ₆₆
D	I/O ₁₄	NC	I/O ₁₅	I/O ₁₆	I/O ₀	I/O ₇₉	I/O ₆₃	I/O ₆₄	CLK ₃ / I ₄	I/O ₆₅
E	I/O ₁₇	CLK ₀ / I ₀	I/O ₁₈	I/O ₁₉	GND	GND	I/O ₆₀	I/O ₆₁	CLK ₂ / I ₃	I/O ₆₂
F	I/O ₂₂	JTAG EN	I/O ₂₁	I/O ₂₀	GND	GND	I/O ₅₉	I/O ₅₈	I ₂	I/O ₅₇
G	I/O ₂₇	CLK ₁ / I ₁	I/O ₂₆	I/O ₂₄	I/O ₂₃	I/O ₅₆	I/O ₅₅	I/O ₅₄	NC	I/O ₅₃
H	I/O ₂₈	I/O ₃₃ TMS	V _{CC}	I/O ₂₅	I/O ₃₉	I/O ₄₀	I/O ₅₂	V _{CC}	I/O ₄₇ TDO	I/O ₅₁
J	I/O ₂₉	I/O ₃₂	I/O ₃₅	V _{CC}	I/O ₃₈	I/O ₄₁	I/O ₄₃	I/O ₄₅	I/O ₄₈	I/O ₅₀
K	I/O ₃₀	I/O ₃₁	I/O ₃₄	I/O ₃₆	I/O ₃₇	I/O ₄₂	I/O ₄₄	I/O ₄₆	I/O ₄₉	NC

Pin Configurations^[20] (continued)
**208-Lead PQFP (N208) / CQFP (U208)
Top View**


5.0V Ordering Information (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
64	154	CY37064P44-154AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37064P44-154JC	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P84-154JC	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-154AC	A100	100-Lead Thin Quad Flat Pack	
		CY37064P44-154AI	A44	44-Lead Thin Quad Flat Pack	Industrial
		CY37064P44-154AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-154JI	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P44-154JXI	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
		CY37064P84-154JI	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-154AI	A100	100-Lead Thin Quad Flat Pack	
		5962-9951902QYA	Y67	44-Lead Ceramic Leadless Chip Carrier	Military
	125	CY37064P44-125AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37064P44-125AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-125JC	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P44-125JXC	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
		CY37064P84-125JC	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-125AC	A100	100-Lead Thin Quad Flat Pack	
		CY37064P100-125AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-125AI	A44	44-Lead Thin Quad Flat Pack	Industrial
		CY37064P44-125AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-125JI	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P84-125JI	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-125AI	A100	100-Lead Thin Quad Flat Pack	
		CY37064P100-125AXI	A100	100-Lead Lead Free Thin Quad Flat Pack	
		5962-9951901QYA	Y67	44-Lead Ceramic Leadless Chip Carrier	Military

5.0V Ordering Information (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
512	125	CY37512P208-125NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37512P256-125BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-125BGC	BG388	388-Ball Plastic Ball Grid Array	
	100	CY37512P208-100NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37512P256-100BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-100BGC	BG388	388-Ball Plastic Ball Grid Array	
		CY37512P208-100NI	N208	208-Lead Plastic Quad Flat Pack	Industrial
		CY37512P256-100BGI	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-100BGI	BG388	388-Ball Plastic Ball Grid Array	
		5962-9952502QZC	U208	208-Lead Ceramic Quad Flat Pack	Military
	83	CY37512P208-83NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37512P256-83BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-83BGC	BG388	388-Ball Plastic Ball Grid Array	
		CY37512P208-83NI	N208	208-Lead Plastic Quad Flat Pack	Industrial
		CY37512P256-83BGI	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-83BGI	BG388	388-Ball Plastic Ball Grid Array	
		5962-9952501QZC	U208	208-Lead Ceramic Quad Flat Pack	Military

3.3V Ordering Information

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
32	143	CY37032VP44-143AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37032VP44-143AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37032VP48-143BAC	BA50	48-Ball Fine Pitch Ball Grid Array	
	100	CY37032VP44-100AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37032VP44-100AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37032VP48-100BAC	BA50	48-Ball Fine Pitch Ball Grid Array	
		CY37032VP44-100AI	A44	44-Lead Thin Quad Flat Pack	Industrial
		CY37032VP44-100AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37032VP48-100BAI	BA50	48-Ball Fine Pitch Ball Grid Array	
		CY37032VP44-100JI	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37032VP44-100JXI	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	

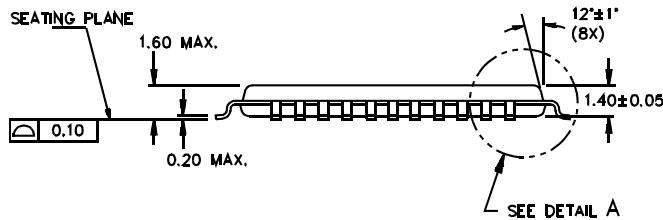
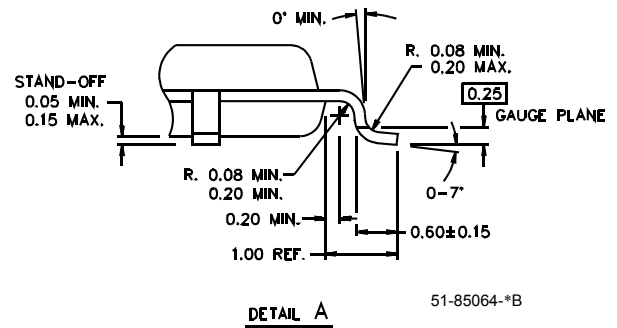
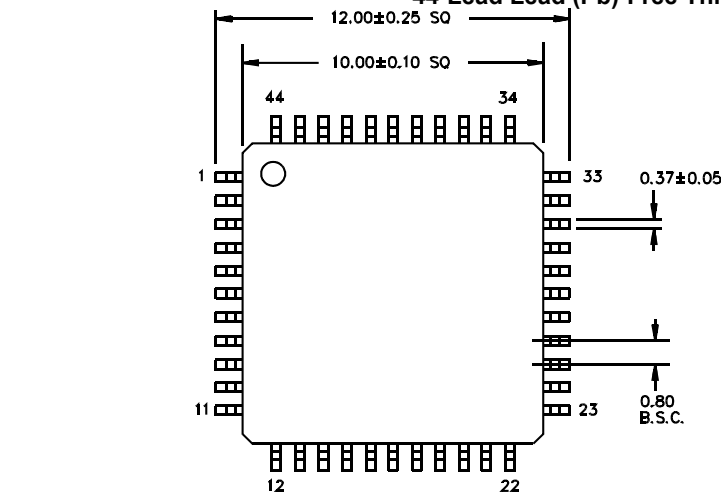
3.3V Ordering Information (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
64	143	CY37064VP44-143AC	A44	44-Lead Thin Quad Flatpack	Commercial
		CY37064VP44-143AXC	A44	44-Lead Lead Free Thin Quad Flatpack	
		CY37064VP48-143BAC	BA50	48-Ball Fine-Pitch Ball Grid Array	
		CY37064VP100-143AC	A100	100-Lead Thin Quad Flatpack	
		CY37064VP100-143AXC	A100	100-Lead Lead Free Thin Quad Flatpack	
		CY37064VP100-143BBC	BB100	100-Ball Fine-Pitch Ball Grid Array	
	100	CY37064VP44-100AC	A44	44-Lead Thin Quad Flatpack	Commercial
		CY37064VP44-100AXC	A44	44-Lead Lead Free Thin Quad Flatpack	
		CY37064VP48-100BAC	BA50	48-Ball Fine-Pitch Ball Grid Array	
		CY37064VP100-100AC	A100	100-Lead Thin Quad Flatpack	
		CY37064VP100-100AXC	A100	100-Lead Lead Free Thin Quad Flatpack	
		CY37064VP100-100BBC	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37064VP44-100AI	A44	44-Lead Thin Quad Flatpack	Industrial
		CY37064VP44-100AXI	A44	44-Lead Lead Free Thin Quad Flatpack	
		CY37064VP48-100BAI	BA50	48-Ball Fine-Pitch Ball Grid Array	
		CY37064VP100-100BBI	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37064VP100-100AI	A100	100-Lead Thin Quad Flatpack	
		CY37064VP100-100AXI	A100	100-Lead Lead Free Thin Quad Flatpack	
		5962-9952001QYA	Y67	44-Lead Ceramic Leaded Chip Carrier	Military
128	125	CY37128VP100-125AC	A100	100-Lead Thin Quad Flat Pack	Commercial
		CY37128VP100-125AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37128VP100-125BBC	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37128VP160-125AC	A160	160-Lead Thin Quad Flat Pack	
		CY37128VP160-125AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	Industrial
		CY37128VP160-125AI	A160	160-Lead Thin Quad Flat Pack	
		CY37128VP160-125AXI	A160	160-Lead Lead Free Thin Quad Flat Pack	
	83	CY37128VP100-83AC	A100	100-Lead Thin Quad Flat Pack	Commercial
		CY37128VP100-83AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37128VP100-83BBC	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37128VP160-83AC	A160	160-Lead Thin Quad Flat Pack	
		CY37128VP160-83AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	Industrial
		CY37128VP100-83AI	A100	100-Lead Thin Quad Flat Pack	
		CY37128VP100-83AXI	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37128VP100-83BBI	BB100	100-Ball Fine-Pitch Ball Grid Array	
		CY37128VP160-83AI	A160	160-Lead Thin Quad Flat Pack	
		CY37128VP160-83AXI	A160	160-Lead Lead Free Thin Quad Flat Pack	
		5962-9952201QYA	Y84	84-Lead Ceramic Leaded Chip Carrier	Military
192	100	CY37192VP160-100AC	A160	160-Lead Thin Quad Flat Pack	Commercial
		CY37192VP160-100AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
	66	CY37192VP160-66AC	A160	160-Lead Thin Quad Flat Pack	Commercial
		CY37192VP160-66AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37192VP160-66AI	A160	160-Lead Thin Quad Flat Pack	Industrial

Package Diagrams

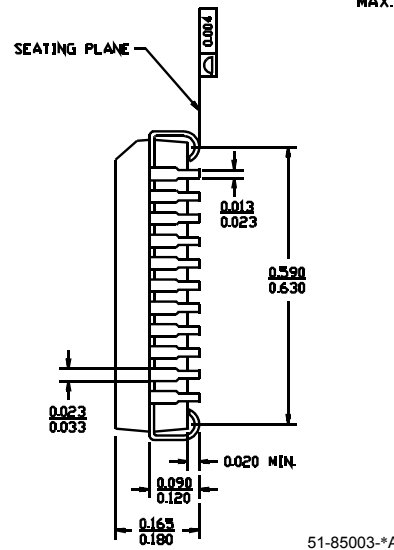
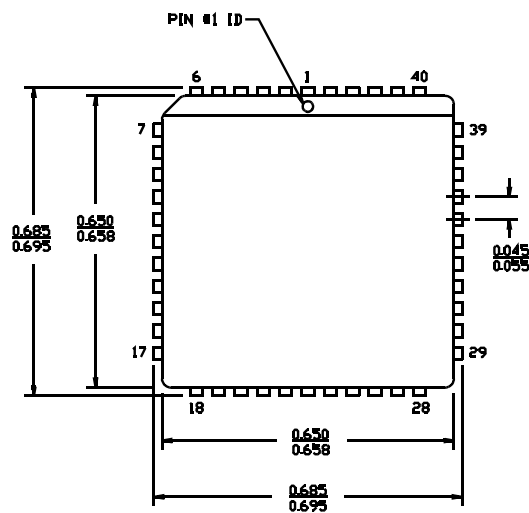
44-Lead Lead (Pb)-Free Thin Plastic Quad Flat Pack A44

DIMENSIONS ARE IN MILLIMETERS



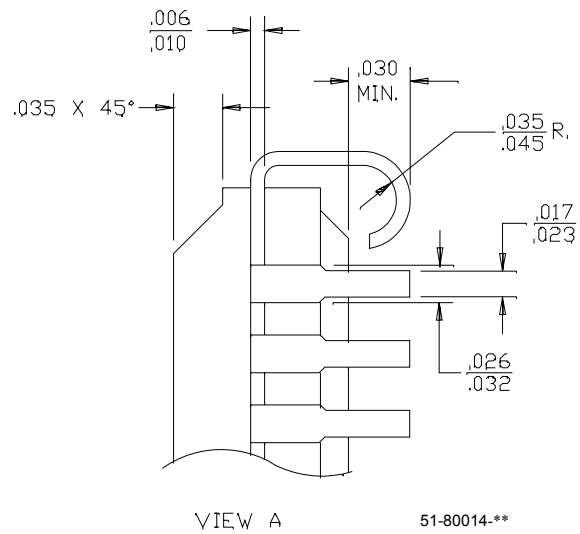
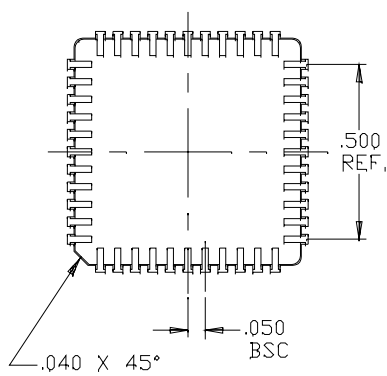
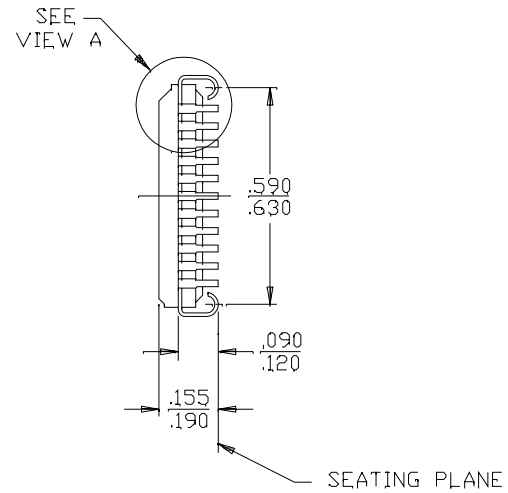
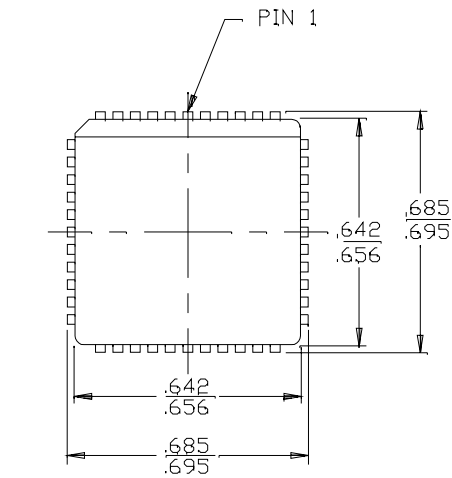
44-Lead Lead (Pb)-Free Plastic Leaded Chip Carrier J67

DIMENSIONS IN INCHES MIN. MAX.



Package Diagrams (continued)

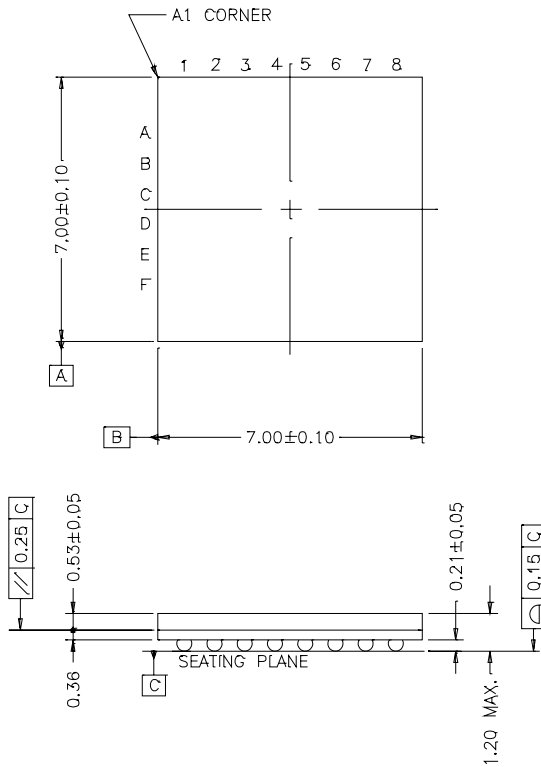
44-Lead Ceramic Leaded Chip Carrier Y67



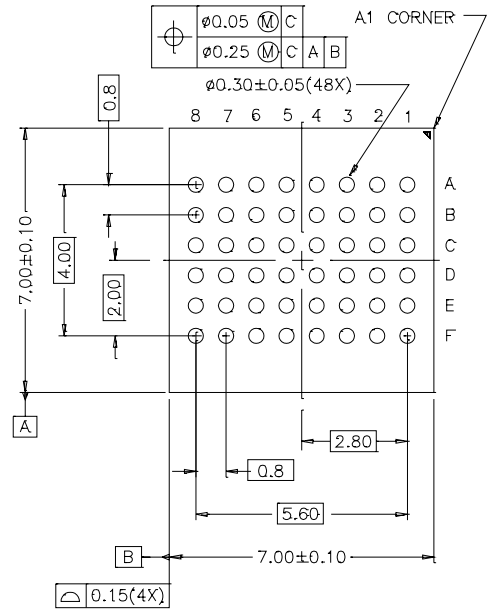
Package Diagrams (continued)

48-Ball (7.0 mm x 7.0 mm x 1.2 mm, 0.80 pitch) Thin BGA BA48D

TOP VIEW



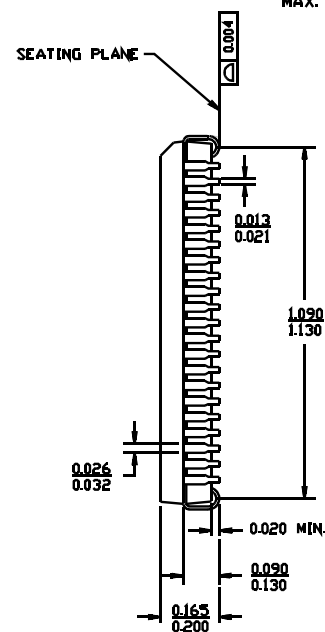
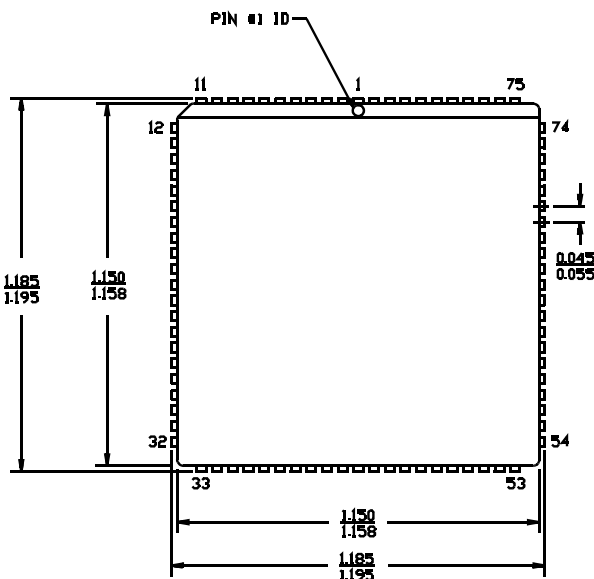
BOTTOM VIEW



51-85109-*C

84-Lead Lead (Pb)-Free Plastic Leaded Chip Carrier J83

DIMENSIONS IN INCHES MIN. MAX.



51-85006-*A

Package Diagrams (continued)

84-Lead Ceramic Leaded Chip Carrier Y84

